ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES	Omposition Dee 005. IPC, Bannockb 1d Pan-American co	claration ourn, Illinois. A opyright conven	ll rights reserved u tions.	Inder both This clevel	locumen parts, the	nt is a declarati e declaration e	on of the sub ncompasses	ostances all lower	within the manufactur r level materials for wl	er listed it hich the m	em. Note: if	the item is an as has engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form			Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				als and Mfg Information				
upplier Information													
Company name*	Company unique ID I			U	Unique ID Authority				Response Date*				
nsemi									2025-05-14				
ontact Name	Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Representative			P	Phone - Representative*			Email - Representative*					
roduct-Env-Stewards	Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	Number	Mfr Item Name		I	Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type
	NXH300 SG	NXH300B100H4Q2F2 Mass market 25 SG		kw 1500v Q2 3 Level	Boost 2	2025-05-14		C	CNG		176241.16	mg	Each
Ianufacturing Proccess Info	rmation												
Terminal Plating / Grid Arra	Terminal Plating / Grid Array Material Terminal Bas		lloy J-STD-020 MSL Rating		ng	Peak Process Body Temperature Max Time at I		e Max Time at Peak	k Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed		CU Alloy NA		NA		0 C		С	30	secon	ds 3		
omments													
or more information regarding mat	erial composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	10330.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		3615.5	mg
		-	Supplier	РВТ	26062-94-2		6714.4995	mg
Case Lid	6420.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		2247	mg
			Supplier	PBT	26062-94-2		4173	mg
DBC	16520.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		6608	mg
			Supplier	Copper (Cu)	7440-50-8		9912	mg
Die	261.157	mg	Supplier	Silicon Carbide	409-21-2		261.157	mg
			Supplier	Silicon (Si)	7440-21-3		0	mg
Glue	410.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		41	mg
			Supplier	Miscellaneous	Trade Secret		41	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		328	mg
Heat Sink	123450.0	mg	В	Nickel (Ni)	7440-02-0		1913.475	mg
			Supplier	Copper (Cu)	7440-50-8		121536.5234	mg
NTC	10.0	mg	Supplier	Silver (Ag)	7440-22-4		0.0979	mg
			Supplier	Tin (Sn)	7440-31-5		0.02	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		3.9169	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0999	mg
			В	Nickel (Ni)	7440-02-0		0.01	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.3997	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		5.4556	mg
Silicone Gel	8400.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		2520	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		5880	mg
Solder Paste	4670.0	mg	Supplier	Silver (Ag)	7440-22-4		303.55	mg
			Supplier	Tin (Sn)	7440-31-5		4366.4502	mg
			Supplier	Copper (Cu)	7440-50-8		-140.0997	mg
Terminal	5210.0	mg	Supplier	Silicon (Si)	7440-21-3		14.067	mg
			В	Nickel (Ni)	7440-02-0		70.335	mg
			Supplier	Copper (Cu)	7440-50-8		5124.2954	mg
			Supplier	Phosphorus (P)	7723-14-0		1.3025	mg
Wire Bond - Al	560.0	mg	Supplier	Aluminum (Al)	7429-90-5		560	mg